

PRELIMINARY SPEC



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Part Number: AAA5060SURVGAPBEC

HYPER RED
GREEN
BLUE

Features

- CHIPS CAN BE CONTROLLED SEPARATELY.
- SUITABLE FOR ALL SMT ASSEMBLY AND SOLDER PROCESS.
- AVAILABLE ON TAPE AND REEL.
- PACKAGE: 500PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- RoHS COMPLIANT.

Description

The Hyper Red source color devices are made with DH InGaAlP on GaAs substrate Light Emitting Diode.

The Green source color devices are made with InGaN on G-SiC Light Emitting Diode.

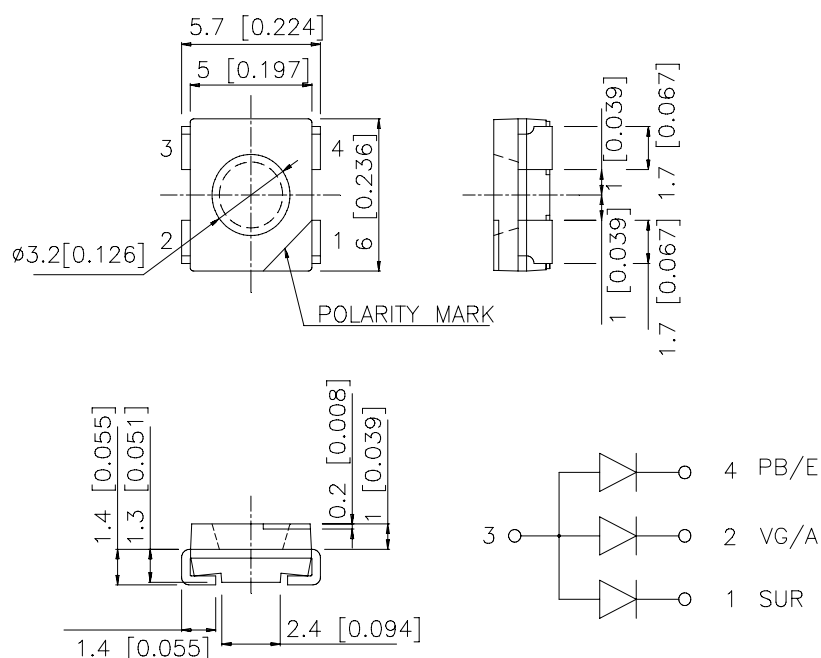
The Blue source color devices are made with InGaN on SiC Light Emitting Diode.

Static electricity and surge damage the LEDs.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25 (0.01") unless otherwise noted.
3. Specifications are subject to change without notice.

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @50mA *30mA		Viewing Angle [1]
			Min.	Typ.	2 θ 1/2
AAA5060SURVGAPBEC	HYPER RED (InGaAlP)	WATER CLEAR	380	500	100°
	GREEN (InGaN)		*180	*350	
	BLUE (InGaN)		*110	*250	

Notes:

- 01/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
- *Luminous intensity with asterisk is measured at 30mA; Luminous intensity / luminous flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ_{peak}	Peak Wavelength	Hyper Red Green Blue	640 520 465		nm	I _F =20mA
λ_D [1]	Dominant Wavelength	Hyper Red Green Blue	628 525 470		nm	I _F =20mA
$\Delta\lambda_{1/2}$	Spectral Line Half-width	Hyper Red Green Blue	27 35 25		nm	I _F =20mA
C	Capacitance	Hyper Red Green Blue	45 100 110		pF	V _F =0V;f=1MHz
V _F [2]	Forward Voltage	Hyper Red Green Blue	1.9 3.2 3.7	2.5 4.0 4.3	V	I _F =20mA
I _R	Reverse Current	Hyper Red Green Blue		10 10 10	uA	V _R = 5V

Notes:

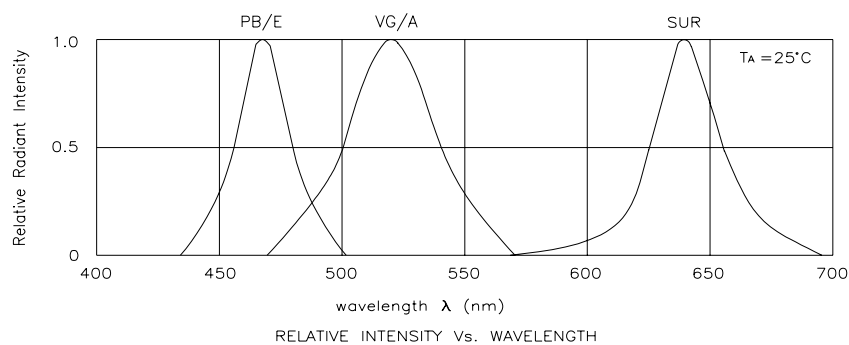
- Wavelength: +/-1nm.
- Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

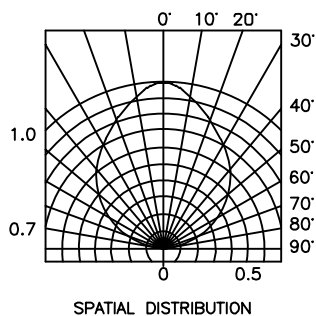
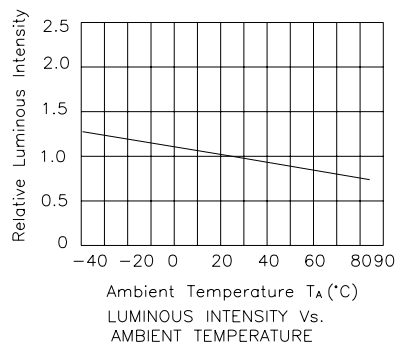
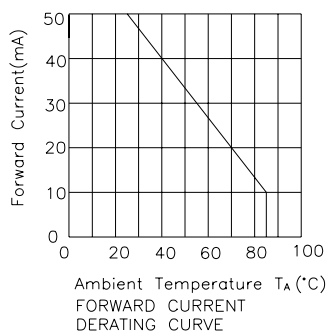
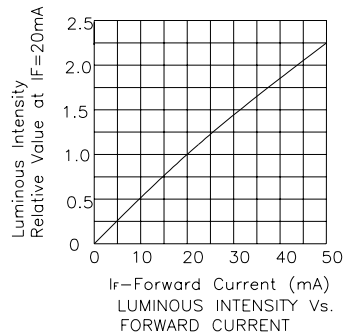
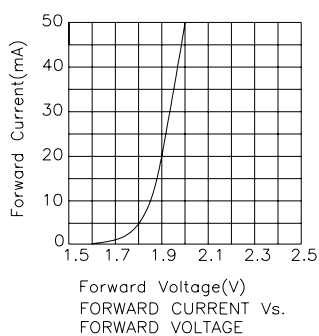
Parameter	Hyper Red	Green	Blue	Units
Power dissipation [2]	350			mW
DC Forward Current	50	50	30	mA
Peak Forward Current [1]	185	100	160	mA
Reverse Voltage	5	5	5	V
Operating / Storage Temperature	-40°C To +85°C			

Notes:

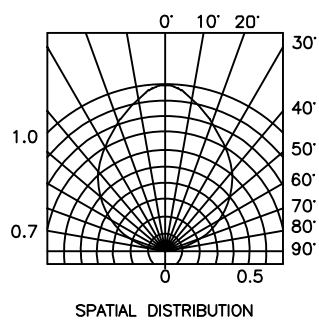
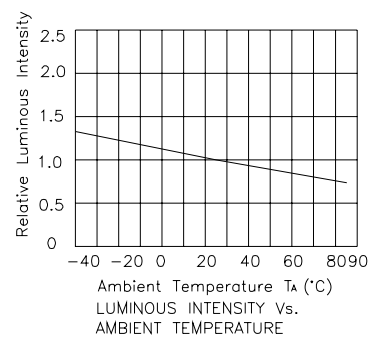
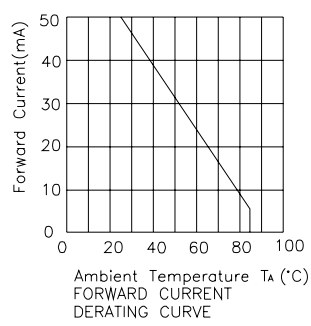
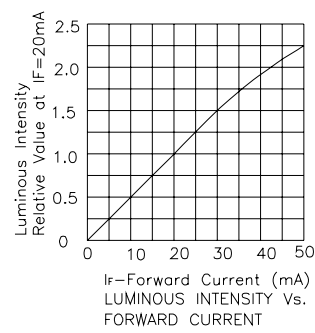
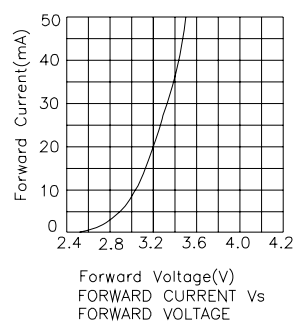
- 1/10 Duty Cycle, 0.1ms Pulse Width.
- Within 350mW at all chips are lightened.



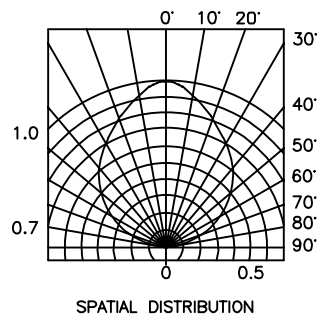
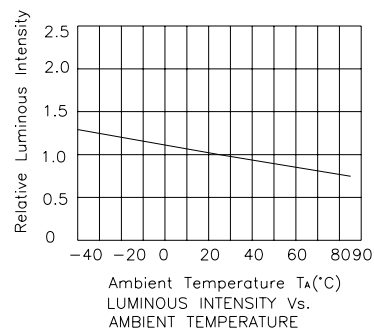
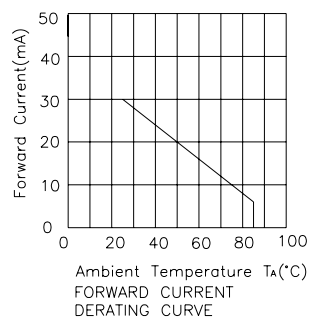
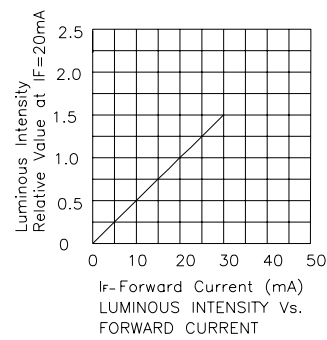
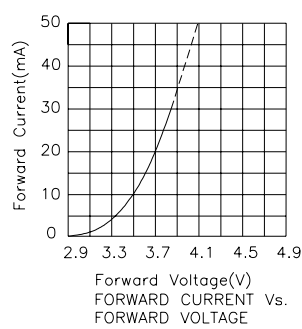
AAA5060SURVGAPBEC
Hyper Red



Green

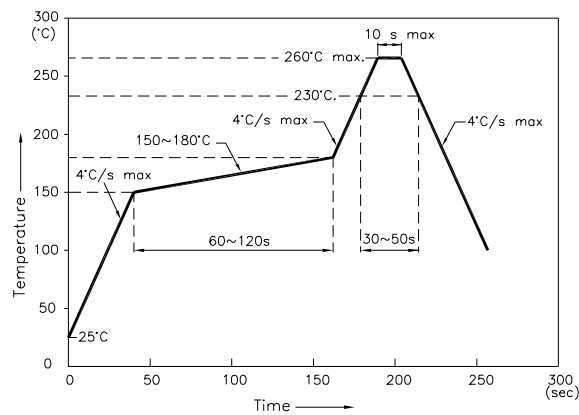


Blue



AAA5060SURVGAPBEC

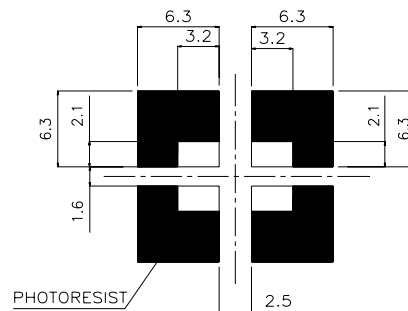
Reflow Soldering Profile For Lead-free SMT Process.



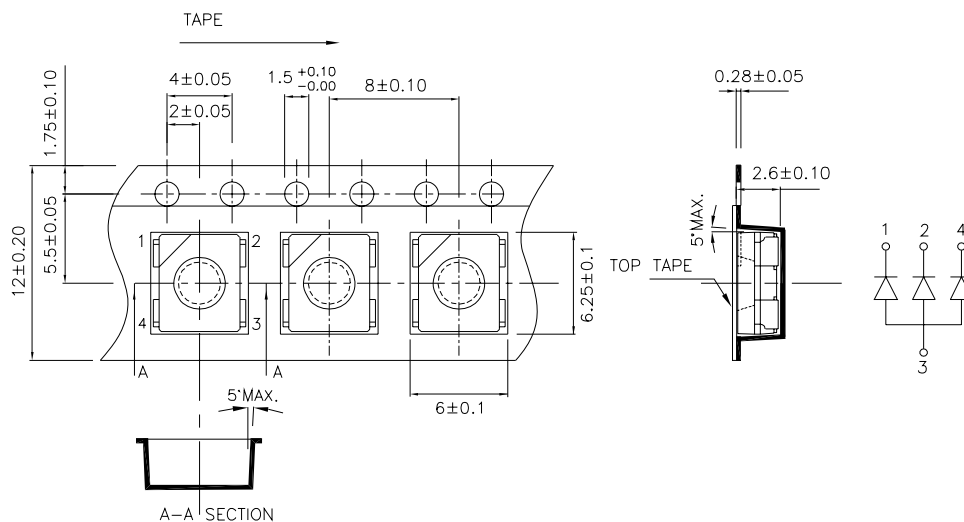
NOTES:

1. We recommend the reflow temperature $245^{\circ}\text{C} (+/-5^{\circ}\text{C})$. The maximum soldering temperature should be limited to 260°C .
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)

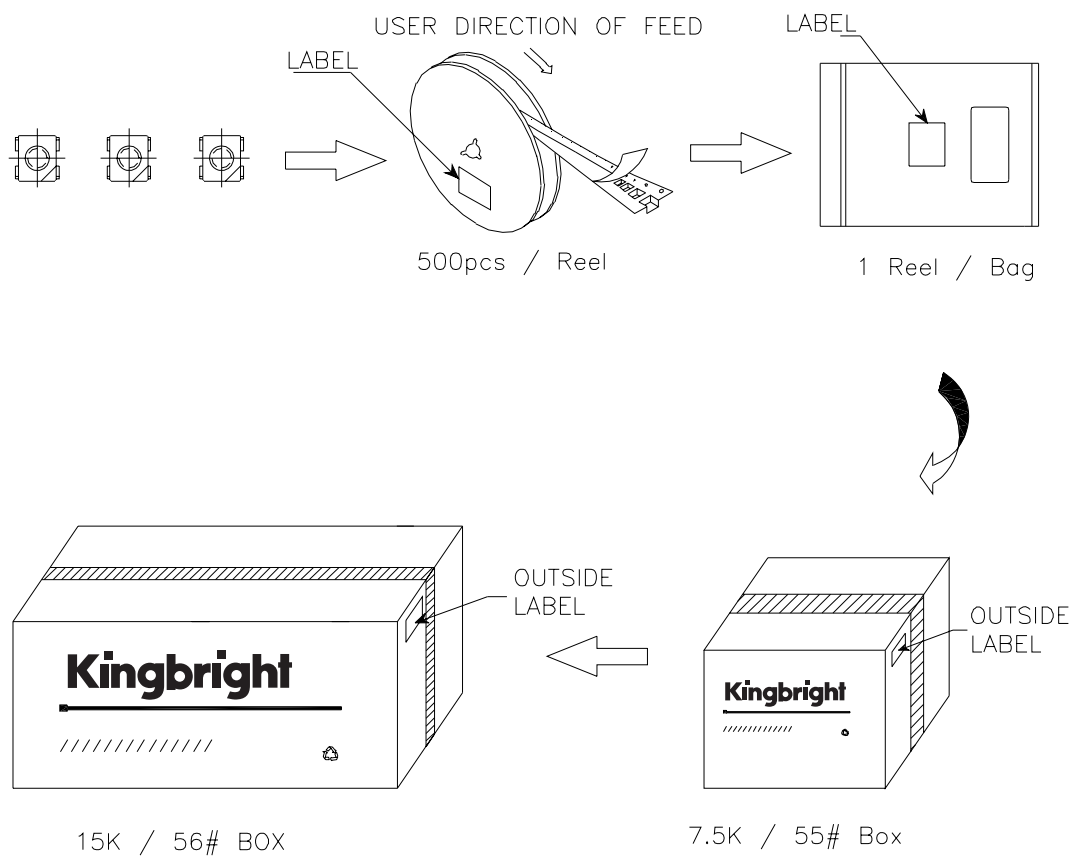


Tape Specifications (Units : mm)



PACKING & LABEL SPECIFICATIONS

AAA5060SURVGAPBEC



Kingbright	
P/NO: AAA5060XXX	
QTY: 500 pcs	Q.C. Q C
S/N: XXXX	XX XX XXX
CODE: XXX	PASSED
LOT NO:	
	
MADE IN CHINA	RoHS Compliant